



7/3/2007

**PRODUCT RELIABILITY REPORT  
FOR**

**DS2784, Rev A2**

**Dallas Semiconductor**

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**Conclusion:**

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

DS2784, Rev A2

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at <http://www.maxim-ic.com/TechSupport/dsreliability.html>.

**Device Description:**

A description of this device can be found in the product data sheet. You can find the product data sheet at [http://dbserv.maxim-ic.com/l\\_datasheet3.cfm](http://dbserv.maxim-ic.com/l_datasheet3.cfm).

**Reliability Derating:**

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k) * (1/Tu - 1/Ts)) = tu/ts$$

AfT = Acceleration factor due to Temperature  
tu = Time at use temperature (e.g. 55°C)  
ts = Time at stress temperature (e.g. 125°C)  
k = Boltzmann's Constant (8.617 x 10<sup>-5</sup> eV/°K)  
Tu = Temperature at Use (°K)  
Ts = Temperature at Stress (°K)  
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B * (Vs - Vu))$$

AfV = Acceleration factor due to Voltage  
Vs = Stress Voltage (e.g. 7.0 volts)  
Vu = Maximum Operating Voltage (e.g. 5.5 volts)  
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X / (ts * AfV * AfT * N * 2)$$

X = Chi-Sq statistical upper limit  
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

$$MTTF = 1/Fr$$

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

<b>FAILURE RATE:</b>	<b>MTTF (YRS):</b>	<b>81270</b>	<b>FITS:</b>	<b>1.4</b>
	<b>DEVICE HOURS:</b>	<b>604000</b>	<b>FAILS:</b>	<b>0</b>

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

**Cf: 60%**      **Ea: 0.7**      **B: 0**      **Tu: 25 °C**      **Vu: 5.5 Volts**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "\*" after DATE CODE denotes specific product data and SEQ No. to identify specific line items in the report for comments when required.

**Device Information:**

Process: E35X-3P3M,DPE2,CrSi,DSD,PDES,D,PDRES,Cap,ENPN,DPT,HTO,SgHalo  
 Passivation: TEOS Ox-Nit Passivation for E35X; Full BEOL at X3; PT only in Dallas  
 Die Size: 98 x 129  
 Number of Transistors: 0  
 Interconnect: Aluminum / 0.5% Copper  
 Gate Oxide Thickness: 120 Å

**DATA RETENTION**

DESCRIPTION	DATE CODE/SEQ	CONDITION	READPOINT	QTY	FAILS	FA#
STORAGE LIFE	0617	150C	1000 HRS	77	0	
STORAGE LIFE	0629	150C	1000 HRS	77	0	
			<b>Total:</b>		<b>0</b>	

**ELECTRICAL CHARACTERIZATION**

DESCRIPTION	DATE CODE/SEQ	CONDITION	READPOINT	QTY	FAILS	FA#
ESD SENSITIVITY	0714 * 1	EOS/ESD S5.1 HBM 500 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0714 * 2	EOS/ESD S5.1 HBM 1000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0714 * 3	EOS/ESD S5.1 HBM 2000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0714 * 4	EOS/ESD S5.1 HBM 3000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0714 * 5	EOS/ESD S5.1 HBM 4000 VOLTS	1 PUL'S	3	1	No FA
LATCH-UP	0714 * 6	JESD78, I-TEST 125C		6	0	
LATCH-UP	0714 * 7	JESD78, V-SUPPLY TEST 125C		6	0	
			<b>Total:</b>		<b>1</b>	

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**OPERATING LIFE**

DESCRIPTION	DATE CODE/SEQ	CONDITION	READPOINT	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0617	125C, 5.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0617	125C, 3.6 VOLTS	1000 HRS	45	0	
HIGH VOLTAGE LIFE	0618	135C, 5.0 V	1000 HRS	45	0	
		135C, 5.0 V	1000 HRS	45	0	
		135C, 5.0 V	1000 HRS	45	0	
HIGH TEMP OP LIFE	0618	125C, 5.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0626	125C, 5.5 VOLTS	1000 HRS	77	0	
HIGH TEMP OP LIFE	0629	125C, 5.5 VOLTS	1000 HRS	77	0	
HIGH TEMP OP LIFE	0632	125C, 3.6V (PSA) & 3.9V (PSB)	1000 HRS	45	0	
HIGH TEMP OP LIFE	0640	125C, 5.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0642	125C, 5.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0651	125C, 3.6 VOLTS	1000 HRS	45	0	
			<b>Total:</b>		<b>0</b>	

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**W/E ENDURANCE AND DATA RET'N**

DESCRIPTION	DATE CODE/SEQ	CONDITION	READPOINT	QTY	FAILS	FA#
WRITE CYCLE STRESS (KCYS)	0626	85 C, 5.5 VOLTS	50 KCYS	77	0	
STORAGE LIFE		150C	1000 HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0640	70 C, 5.5 VOLTS	50 KCYS	77	0	
STORAGE LIFE		150C	1000 HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0642	50 C, 5.5 VOLTS (PSA), 15.0 VOLTS (PSB)	10 KCYS	77	0	
STORAGE LIFE		150C	500 HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0642	50 C, 5.5 VOLTS (PSA), 15.0 VOLTS (PSB)	1 KCYS	77	0	
STORAGE LIFE		150C	1000 HRS	77	0	
WRITE CYCLE STRESS (CYS)	0642	50 C, 5.5 VOLTS (PSA), 15.0 VOLTS (PSB)	100 CYS	77	0	
STORAGE LIFE		150C	1000 HRS	77	0	
WRITE CYCLE STRESS (KCYS)	0714 * 2	50 C, 5.5 V (PSA) & 15.0 V (PSB)	10 KCYS	77	0	
STORAGE LIFE	* 2	150C	96 HRS	77	0	
			<b>Total:</b>		<b>0</b>	

**FAILURE RATE:**                    **MTTF (YRS):**            **81270**      **FITS:**            **1.4**  
   **DEVICE HOURS:**        **604000**    **FAILS:**            **0**